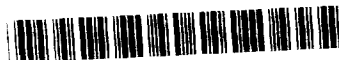


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1. Name of conveying party(ies):
Szetsen Steven LEE

Additional name(s) of conveying parties attached? YES NO

3. Nature of conveyance:

Assignment Merger

Security Agreement Change of Name

Other _____

Execution Date: April 5, 2000

2. Name and address of receiving parties:

Name: WINBOND ELECTRONICS CORP.

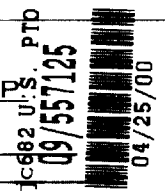
Internal Address: _____

Street Address: No. 4, Creation Rd. III
Science-Based Industrial Park

City: Hsinchu State: _____

Zip: _____ Country: Taiwan, R.O.C.

Additional name(s) & address(es) attached? YES NO



4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: April 5, 2000

A. Patent Application No(s): _____ B. Patent No(s): 09/557125

Additional numbers attached? YES NO

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Richard P. Berg
LADAS & PARRY

Internal Address: _____

Street Address: 5670 Wilshire Boulevard, #2100

City: Los Angeles State: CA Zip: 90036-5679

6. Total number of application and patents involved: 1

7. Total fee 937 CFR 3.41).....\$ 40.00

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PATENT
REEL: 010767 FRAME: 0053

ASSIGNMENT

WHEREAS, Szetsen Steven LEE
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:

Title: OPTICAL TEMPERATURE MEASUREMENT AS AN IN SITU MONITOR OF
ETCH RATE

Filed: _____ Serial No. _____

Executed on: April 5, 2000

WHEREAS, Winbond Electronics Corp. of No. 4, Creation
Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the
said invention and application and in any U.S. Letters Patent which may be granted on the
same:

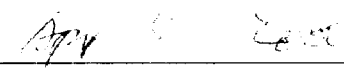
NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their
rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on the
same in the United States, the said interest to be held and enjoyed by said Assignee as fully
and exclusively as it would have been held and enjoyed by said Assignor had this Assignment
and transfer not been made, to the full end and term of any Letters Patent which may be
granted thereon, or of any division, renewal, continuation in whole or in part, substitution,
conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments
of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.



Szetsen Steven LEE



Date: